Application Data Sheet

Secrecy Order in Parent Appl.::

Application Information Application number:: Filing Date:: Application Type:: Regular Subject Matter:: Utility Suggested classification:: Suggested Group Art Unit:: CD-ROM or CD-R??:: Number of CD disks:: Number of copies of CDs:: Sequence Submission:: Computer Readable Form (CRF)?:: Number of copies of CRF:: Title:: METHOD FOR FABRICATING SEMICONDUCTOR DEVICE 00939H-087400US Attorney Docket Number:: Request for Early Publication:: No Request for Non-Publication:: No Suggested Drawing Figure:: **Total Drawing Sheets:** 6 Small Entity?:: No Latin name:: Variety denomination name:: Petition included?:: No Petition Type:: Licensed US Govt. Agency:: Contract or Grant Numbers One::

No

Applicant Information

Applicant Authority Type::

Inventor

Primary Citizenship Country::

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Status::

Full Capacity

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State or Province of Residence::

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Correspondence Information

Correspondence Customer Number::

20350

Representative Information

Representative Customer Number::

20350

Domestic Priority Information

Application::

Continuity Type::

Parent Application:: Parent Filing Date::

Foreign Priority Information

Country::

Application number::

Filing Date::

Korea, South

2003-35281

06/02/03

Assignee Information

Assignee Name::

Hynix Semiconductor Inc.

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